

Field X-ray instrument

Portable stress analyzer





Better measurements. Better confidence. Better world.

The World's Smallest Stress Analyzer



[†]As of August 2014

1

Unique Features

The world's smallest instrument design

The world's smallest measurement head is 114(W) x 248(D) x 111(H) mm and weighs 3 kg. It enables measurement of residual stress in the inner surface of 200 mm \$\phi\$ pipe.



Rapid data acquisition

A high-speed 2-dimensional semiconductor detector and single-exposure method accelerates data acquisition. Residual stress is measured in 60 seconds or less in most cases.



Remote operation through a tablet PC and Wi-Fi

The instrument is remotely controlled by a tablet PC with Wi-Fi communication.



Built-in utilities

The instrument is powered by an optional exchangeable battery. There is no need to have utilities in field, e.g. cooling liquid and electricity.



Application Examples

Residual stress measurement on shot peened steel



Figure 1. Arrangement of head unit and sample



Figure 3. Stress principal axes $(\sigma_{_1},\sigma_{_2})$ and sample coordinate (X, Y)

Sample type

Typical sample types for residual stress measurement are summarized in the table. Other steel samples can also be measured. The sample shape is arbitrary: thanks to the device's compact design, sheets, bulk materials, springs, gears and pipes can be measured without major sample preparation.





Figure 2. A 2-D Debye-Scherrer diffraction ring of α -Fe 211 diffraction



Figure 4. Residual stress analysis result

Examples of sample type

Sh	ot peening			
•	Multistage shot peening	•	Warm shot peening	
•	High-hardness shot peening	•	Stress shot peening	
•	Fine shot peening			
Pla	stic working			
•	Casting	•	Pultrusion	
•	Extrusion	•	Machining	
•	Rolling	•	Pressing	
Ge	neral heat treatment			
•	Hardening			
•	Annealing			
Su	rface heat treatment			
•	High-frequency hardening			
•	Carburizing			
We	lding			
Gri	Grinding and polishing			
Sur	face reforming			
Ma	intenance of plant and infrastructure			

The shot peening process creates high residual stress at the peened area. A shot peened steel sample was aligned by monitoring an image displayed on a tablet PC as recorded by an integrated CCD camera with the aid of a laser marker (See Figure 1 and the next page for sample alignment details). Predefined material and measurement parameters were used for evaluation. A Debye-Scherrer diffraction ring of α -Fe 211 was recorded by the 2-dimensional semiconductor detector (Figure 2). Exposure time was 60 seconds. Principal stresses σ_1 and σ_2 were calculated and displayed with the sample image taken by the CCD camera (Fig. 3). Residual stress σ_{11} and its share component σ_{12} were calculated as -1278.9 and -46.1 MPa, respectively (Fig. 4). These data, including the sample image and Debye-Scherrer diffraction ring, are stored and summarized in a report.

Easy Alignment and Measurement

CCD sample observation camera and laser marker



The measured point on the sample surface is indicated by a laser marker and is displayed on the tablet PC. White LEDs illuminate the sample for low-light work environments, e.g. inside a pipe. Sample image is stored together with measurement data and attached to the report.



Sample alignment using sensors

The distance to the sample surface and the incident angle of the X-rays are measured by a laser displacement sensor as well as 3-dimensional (3D) accelerometer and displayed on the tablet PC. An operator is able to adjust these parameters easily by following indicators on the display.



Single-click measurement and analysis



Material-related parameters for each phase (e.g., Young's modulus, Poisson's ratio, Bragg angle of diffraction) are pre-installed in the instrument control software. Options for the residual stress calculation are selectable with regards to stress model, LPA (Lorentz-polarization and absorption) correction, wavelength component and BG (background) mode. Those parameters are saved as recipes together with measurement conditions. Measurement setup is easy. For daily use, the operator simply selects the type of application on the tablet PC and carries out the measurement. From data collection to reporting, all of the procedures are done by single-click operations.

For the expert user, detailed measurement and analysis conditions are editable through the instrument control software. An expert user can also edit material parameters in recipes for residual stress calculation.



Safety and Traceability

Safety is our top priority



This portable device is designed for field analysis, and can be used in open space environments. Integrated laser displacement sensor and three-dimensional (3D) accelerometer measure distance to the sample and the position of the device. Unless those parameters are set properly, X-rays cannot be illuminated onto the sample. The multiple step safety algorithm protects the operator from exposure to radiation.

For indoor laboratory use, an optional radiation enclosure is available. It ensures a safe operational environment in the laboratory.

Calibration standards for measurement traceability



Calibration records can be recalled at any time from the history view. This assures the measurement traceability of the instrument.

Measurement traceability is maintained by means of periodic calibration. SmartSite RS is delivered with instrument calibration standards, including steel powder, bulk steel and fluorescence powder. The steel powder calibrates "zero" stress and the absolute scale of residual stress is ensured by measuring the bulk steel sample, which has approximately -100 MPa of residual stress. Location and size of the X-ray spot on a sample is determined using the fluorescence powder standard.

Date	Tuesday	y, June 24, 2014		~	
Comment				~	
Date	Comment	σ11	σ12	FWHM	
2014-06-13 15:14:06	powder	-6.1	5.5	1.5	
2014-06-13 13:16:13	gear	-1094.4	-75.7	6.3	
2014-06-13 12:28:09	gear-s-btm2	-250.9	-46.4	5.1	
2014-06-13 12:25:32	gear-l-btm2	-129.9	-50.4	4.7	
2014-06-13 12:18:33	gear-l-btm	-1269.2	-107.8	6.9	
2014-06-13 12:16:04	gear-s-btm	-1087.5	39.0	5.9	
2014-06-13 11:52:54	gear-L	-1744.1	-165.9	6.5	
2014-06-13 11:50:06	gear-s	-1686.6	-7.6	5.5	
2014-06-13 11:45:59	bulk	-149.4	-7.3	1.6	
2014-06-13 11:45:03	bulk	-161.3	-7.2	1.6	
2014-06-13 11:36:52	powder	-1.7	-3.6	1.5	

Specifications

Dimensions		
Head unit (excluding ball joint)	114 x 248 x 111 mm, 4.5 x 9.8 x 4.4 inch (W x D x H) approximately 3 kg, 6.6 lbs	
Power supply unit	230 x 470 x 460 mm, 9.1 x 18.5 x 18.1 inch (W x D x H) approximately 20 kg, 44.1 lbs	
High voltage cable	5 m	
Storage for transportation	1x carrying case included	

Residual stress measurement

Materials to be measured	Steel, aluminum (optional)
Residual stress calculation	General equation (Rigaku original)
Stress component	Biaxial stress
X-ray tube	Chromium radiation (Cr), 30 kV - 50 W
X-ray incident angle	35°
X-ray beam size	1 mm ϕ (with collimator), 2 mm ϕ (without collimator)
Measurement time	approximately 60 seconds
X-ray detector	High-speed semiconductor 2-dimensional detector
X-ray detector size	2x (38.5 x 19.3 mm)
2θ range	145° ~ 165°
Sample-detector distance	45 mm

Operation

PC	Windows 8.1 tablet PC
Communication	Wireless (Wi-Fi)

Environment, Utility, Safety

Environment	Dust resistance
Temperature range	$-10 \sim +50^{\circ}$ C with less than $\pm 4^{\circ}$ C fluctuation
Humidity range	1 ~ 70 % R.H. with less than \pm 10 % R.H. fluctuation
Power supply	AC 100 - 240V or optional built-in battery
Safety mechanism	Safety mechanism by three-dimensional (3D) acceleration and laser displacement sensors, emergency stop switch, safety key



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www.Rigaku.com



Rigaku Corporation and its Global Subsidiaries

website: www.Rigaku.com | email: info@Rigaku.com



Rigaku is proudly represented in Australia and New Zealand by AXT Pty. Ltd. 1/3 Vuko Pl., Warriewood NSW 2102 Australia T. +61 (0)2 9450 1359 F. +61 (0)2 9450 1365 W. www.axt.com.au E. info@axt.com.au